



TECHNICAL DATA SHEET

Sn100 Solder Bar

Lead Free



Description

Kurtel Sn100 soldering bar can be used in lead-free applications and is manufactured in accordance with **RoHS II** (2011/65 / EU) directives. Sn100 solder bar can be used as a feeding ingot in order to reduce the copper ratio to desired values in alloys formed by tin with silver and / or copper. Made of high purity A + tin, Sn100 solder bar has low unwanted impurity rates. In this way, the solderability performance is increased by reducing the amount of impurities in the solder pot.

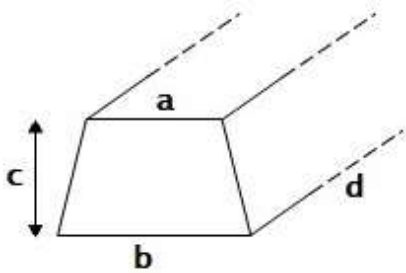
Advantages;

- RoHS II
- Lower density than lead alloys

Physical Properties & Product Forms

Properties	Sn100
Solder composition:	Sn %99,5 ($\pm 0,15$)
Melting Point:	231,9 °C Liquidus
Specific Gravity:	7,31 g/cm ³

Kurtel Sn100 solder bar is trapezoidal 0,95 kg ingot form in 20kg box packages.



Dimensions

a : 20 mm
b : 24 mm
c : 17 mm
d : 350 mm



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Storage & Shelf Life

Dry at room temperature. Solder has an indefinite shelf life.

Health & Safety

Before using please read the MSDS